

# NPS4001

## 5.5 V, 55 mΩ load switch with current limitation

Rev. 1 — 25 April 2024

Product data sheet

## 1. General description

The NPS4001 is a 5.5 V, 55 mΩ load switch suitable for applications up to 2 A.

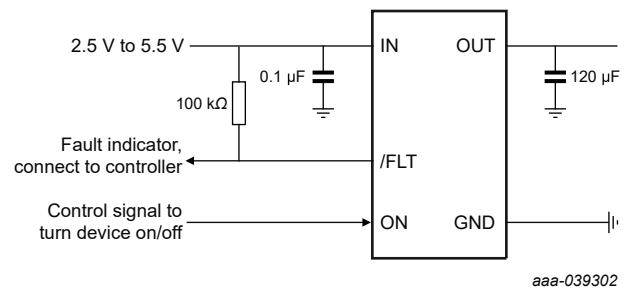
The NPS4001 switch limits the output current to a constant current by using a constant-current mode when the output load exceeds the current limit threshold or shorted. An internal voltage comparator disables the load switch when the output voltage is higher than the input to protect devices on the input side of the switch. The FLG pin is an active low output to indicate overcurrent, over temperature and reverse voltage conditions.

## 2. Features and benefits

- Input operating voltage range ( $V_{IN}$ ): 2.5 V to 5.5 V
- Rated current ( $I_{MAX}$ ): 2 A
- ON resistance ( $R_{DS(on)}$ ):
  - $V_{IN} = 5.5$  V: 55 mΩ (typical)
  - $V_{IN} = 3.6$  V: 65 mΩ (typical)
  - $V_{IN} = 2.5$  V: 80 mΩ (typical)
- Constant current during current limit
- No body diode when disabled (no current path from pin OUT to pin IN)
- Active reverse voltage protection
- Built in soft start
- UL 62368 recognition
- SOT753 (TSOP5) package
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C2a exceeds 500 V
  - IEC 61000-4-2 contact discharge 8000 V
  - IEC 61000-4-2 air-gap discharge 15000 V
- Specified from -40 °C to +125 °C

## 3. Applications

- USB ports/hubs, laptops, docking station and desktops
- Set top box
- HDTV
- Optical socket protection
- Current limiting circuits



**Note:** For USB port applications, connect a capacitor of at least 120 μF at the output. For other applications, choose output capacitor according to actual transit requirements.

Fig. 1. Typical application circuit

## 4. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
<a href="#">NPS4001GV</a>	-40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	<a href="#">SOT753</a>

## 5. Marking

Table 2. Marking

Type number	Marking code
NPS4001GV	s7

## 6. Functional diagram

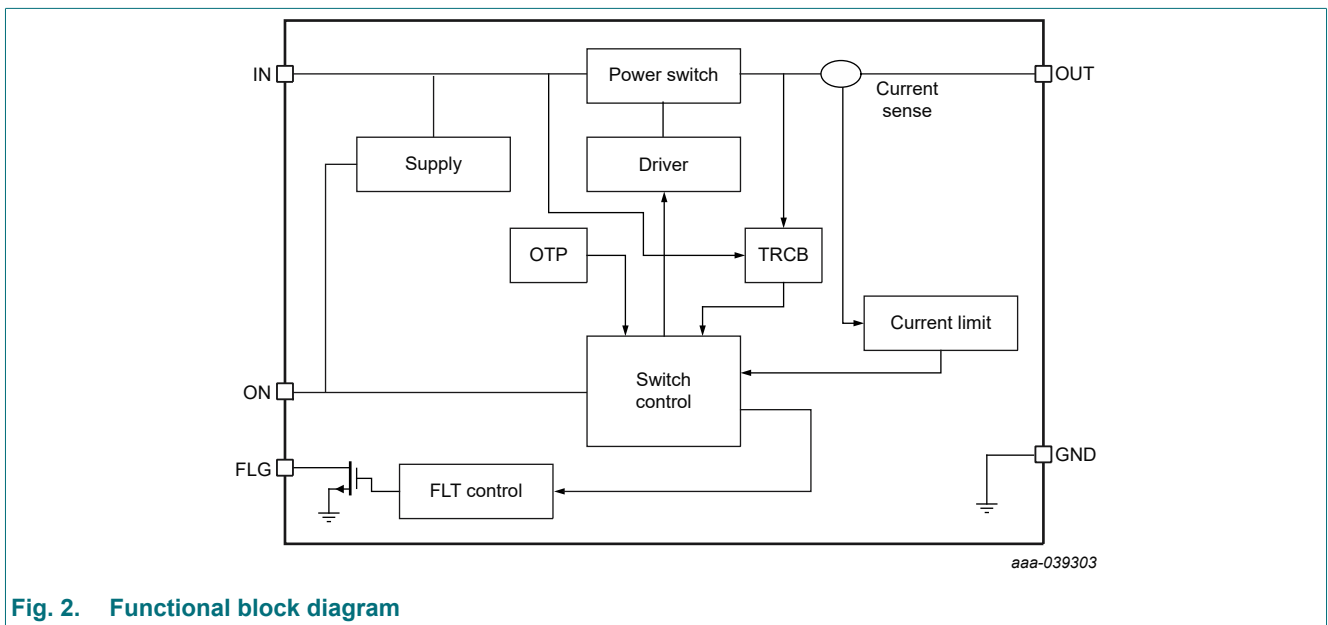
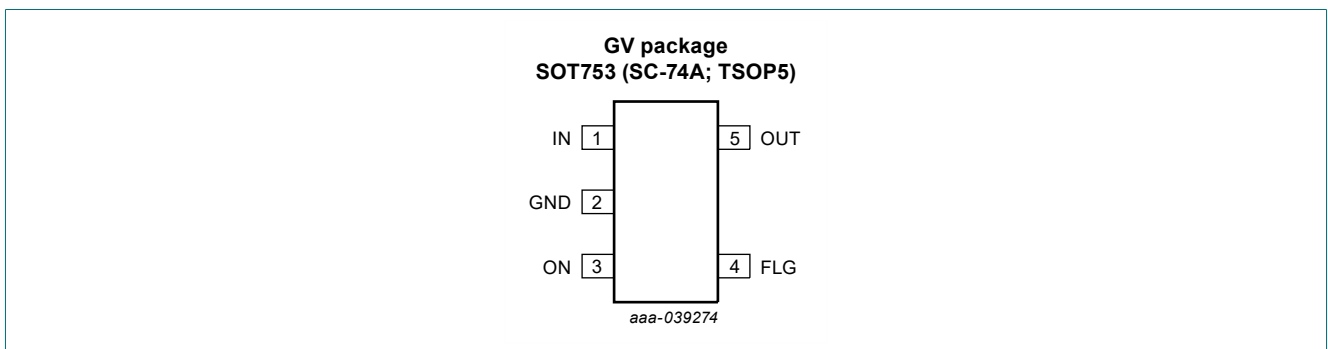


Fig. 2. Functional block diagram

## 7. Pinning information

### 7.1. Pinning



## 7.2. Pin description

Table 3. Pin description

Symbol	Pin	I/O	Description
IN	1	Supply	Power-switch input pin. Connect a ceramic capacitor of minimal 0.1 μF from pin IN to GND, as close to the IC as possible.
GND	2	Supply	Ground connection; connect externally to PCB ground.
ON	3	I	ON/OFF (enable) input. LogicHIGH turns on power switch.
FLG	4	O	Active-low open-drain output, pulled up to VIN or other power rails via external resistor. Asserts low during overcurrent, overtemperature and reverse-voltage conditions. Can be shorted to GND or floating if not used.
OUT	5	O	Power-switch output pin. Connect at least 120 μF capacitor at output for USB port application. Choose output capacitor according to actual transient requirements for other applications other than USB.

## 8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V). [1]

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>IN</sub>	input voltage	pin IN	-0.3	+6	V
V <sub>OUT</sub>	output voltage	pin OUT	-0.3	+6	V
V <sub>ON</sub>	ON/OFF (enable) input voltage	pin ON	-0.3	+6	V
V <sub>FLG</sub>	FLG pin voltage	pin FLG	-0.3	+6	V
V <sub>IN</sub> - V <sub>OUT</sub>	voltage range from pin IN to pin OUT		-6	+6	V
I <sub>FLG</sub>	FLG pin sink current	pin FLG	0	25	mA
T <sub>j</sub>	junction temperature		-40	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C
<b>ESD</b>					
V <sub>ESD</sub>	electrostatic discharge voltage	HBM ANSI/ESDA/JEDEC JS-001	-2	+2	kV
		CDM ANSI/ESDA/JEDEC JS-002	-0.5	+0.5	kV
		IEC 61000-4-2 contact discharge	-8	+8	kV
		IEC 61000-4-2 air-gap discharge	-15	+15	kV

- [1] Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

## 9. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{IN}$	input voltage	pin IN	2.2	5.5	V
$V_{ON}$	ON/OFF (enable) input voltage	pin ON	0	5.5	V
$V_{IH}$	HIGH-level input voltage	ON pin	1.4	-	V
$V_{IL}$	LOW-level input voltage	ON pin	0	0.35	V
$I_{OUT}$	continuous output current		0	2	A
$I_{FLG}$	continuous sink current pin FLG		0	10	mA
$T_{amb}$	ambient temperature		-40	+125	°C

## 10. Thermal Information

Table 6. Thermal information

Thermal resistance according JEDEC51 -5 and -7

Symbol	Parameter	Measurement	Unit
$R_{\theta JA}$	Junction to ambient thermal resistance	160	°C/W
$R_{\theta JC(top)}$	Junction to case(top) thermal resistance	132.1	°C/W
$\Phi_{JT}$	Junction to top char parameter	21.1	°C/W
$\Phi_{JB}$	Junction to board char parameter	37.1	°C/W

## 11. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

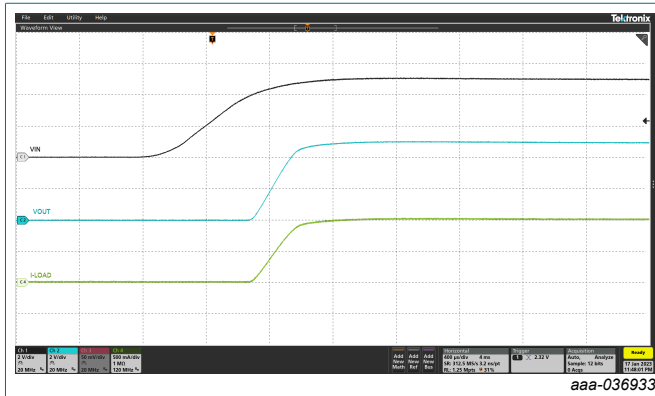
$V_{IN} = 5\text{ V}$ ,  $R_{FLG} = 100\text{ k}\Omega$ , all typical values are measured at  $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified.

Symbol	Parameter	Conditions	$T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$			Unit
			Min	Typ	Max	
<b>POWER SWITCH</b>						
$R_{DS(on)}$	drain-source on-state resistance	$V_{IN} = 5.5\text{ V}$	-	55	88	mΩ
		$V_{IN} = 3.6\text{ V}$	-	65	109	mΩ
		$V_{IN} = 2.5\text{ V}$	-	80	140	mΩ
$t_r$	rise time output	$C_L = 1\text{ }\mu\text{F}$ ; $R_L = 100\text{ }\Omega$				
		$V_{IN} = 5.5\text{ V}$	-	0.3	1	ms
		$V_{IN} = 2.5\text{ V}$	-	0.2	1	ms
$t_f$	fall time output	$C_L = 1\text{ }\mu\text{F}$ ; $R_L = 100\text{ }\Omega$				
		$V_{IN} = 5.5\text{ V}$	-	0.2	0.3	ms
		$V_{IN} = 2.5\text{ V}$	-	0.2	0.3	ms
<b>ON/OFF INPUT</b>						
$I_{ON}$	input current	$V_{ON} = 0\text{ V}$ or $5.5\text{ V}$	-0.5	-	0.5	uA
$t_{on}$	turn-on time	$V_{IN} = 2.5\text{ V}$ to $5.5\text{ V}$ ; $C_L = 1\text{ }\mu\text{F}$ ; $R_L = 100\text{ }\Omega$	-	-	3	ms
$t_{off}$	turn-off time	$V_{IN} = 2.5\text{ V}$ to $5.5\text{ V}$ ; $C_L = 1\text{ }\mu\text{F}$ ; $R_L = 100\text{ }\Omega$	-	-	3	ms
$I_{LIMIT}$	current-limit threshold	$V_{IN} - V_{OUT} = 1.0\text{ V}$	1.58	2.37	3.17	A

## 5.5 V, 55 mΩ load switch with current limitation

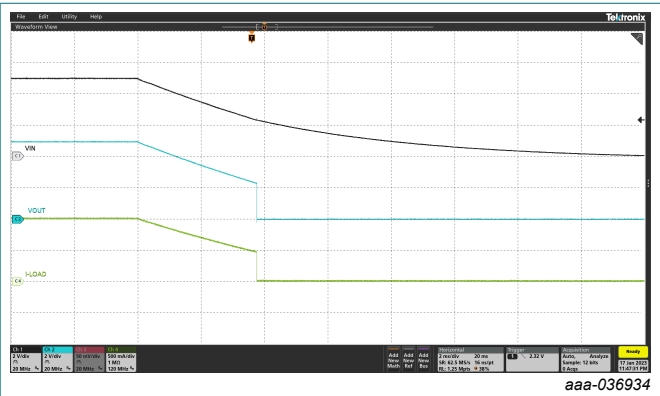
Symbol	Parameter	Conditions	T <sub>amb</sub> = -40 °C to +125 °C			Unit
			Min	Typ	Max	
<b>REVERSE VOLTAGE PROTECTION</b>						
V <sub>reverse</sub>	reverse-voltage comparator trip point		-	75	110	mV
t <sub>reverse</sub>	time from reverse-voltage condition to MOSFET turn off	V <sub>IN</sub> = 4 V; V <sub>OUT</sub> = 5 V	-	0.5	5	μs
<b>SUPPLY CURRENT</b>						
I <sub>q</sub>	quiescent current	V <sub>IN</sub> = V <sub>ON</sub> = 5.5 V; no load on pin OUT	-	-	285	μA
I <sub>SD</sub>	shut down current	V <sub>IN</sub> = 5.5 V; no load on pin OUT, V <sub>ON</sub> = 0 V	-	-	1	μA
I <sub>REV</sub>	reverse current leakage	V <sub>IN</sub> = 0 V; V <sub>OUT</sub> = 5.5 V	-	150	-	nA
<b>UNDERVOLTAGE LOCKOUT</b>						
V <sub>UVLO</sub>	under voltage lockout low-level input voltage	V <sub>IN</sub> rising	-	2.35	2.45	V
V <sub>hys(UVLO)</sub>	undervoltage lockout hysteresis voltage	T <sub>j</sub> = 25 °C	-	25	-	mV
<b>FLG INDICATOR</b>						
V <sub>OL</sub>	LOW-level output voltage	I <sub>FLG</sub> = 1 mA	-	-	180	mV
I <sub>S(OFF)</sub>	OFF-state leakage current	V <sub>FLG</sub> = 5.5 V	-	-	1	μA
t <sub>degl</sub>	deglitch time	FLG assertion or de-assertion due to overcurrent condition	-	8.5	12	ms
		FLG assertion or de-assertion due to reverse-voltage condition	-	0.2	1	ms
<b>THERMAL SHUTDOWN</b>						
T <sub>th(sd)</sub>	shutdown threshold temperature		155	-	-	°C
T <sub>sd(hys)</sub>	shutdown temperature hysteresis		-	10	-	°C

11.1. Typical characteristics



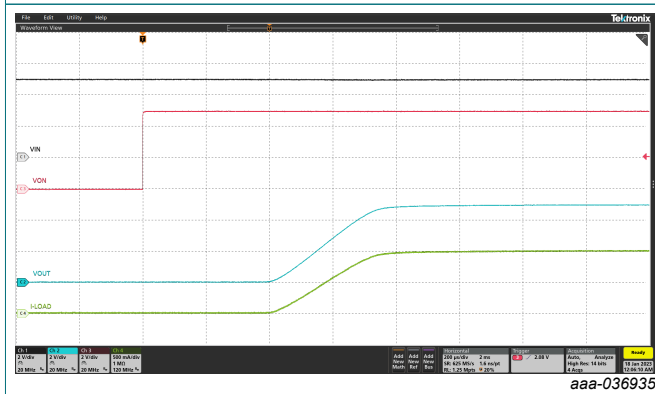
$V_{IN}=5\text{ V}$ ,  $C_{OUT} = 1\ \mu\text{F}$ ,  $I_{load} = 1\text{ A}$

Fig. 3. Turn ON



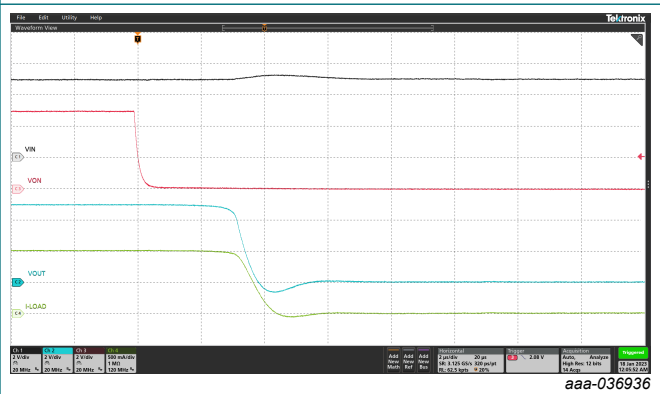
$V_{IN}=5\text{ V}$ ,  $C_{OUT} = 1\ \mu\text{F}$ ,  $I_{load} = 1\text{ A}$

Fig. 4. Turn OFF



$V_{IN}=5\text{ V}$ ,  $V_{ON}=5\text{ V}$ ,  $C_{OUT} = 1\ \mu\text{F}$ ,  $I_{load} = 1\text{ A}$

Fig. 5. Enable



$V_{IN}=5\text{ V}$ ,  $V_{ON}=5\text{ V}$ ,  $C_{OUT} = 1\ \mu\text{F}$ ,  $I_{load} = 1\text{ A}$

Fig. 6. Disable

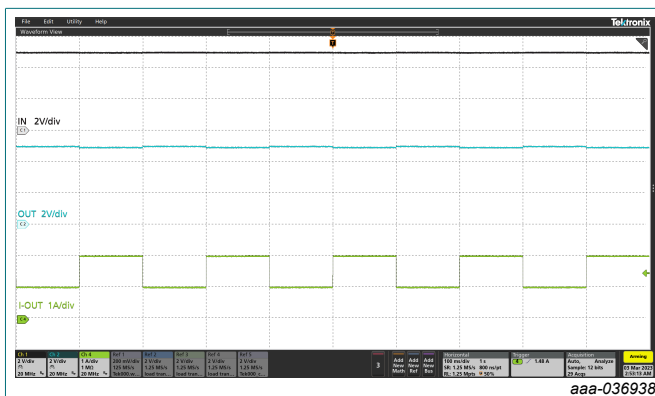


Fig. 7.  $V_{IN}$  transient 1 A to 2 A

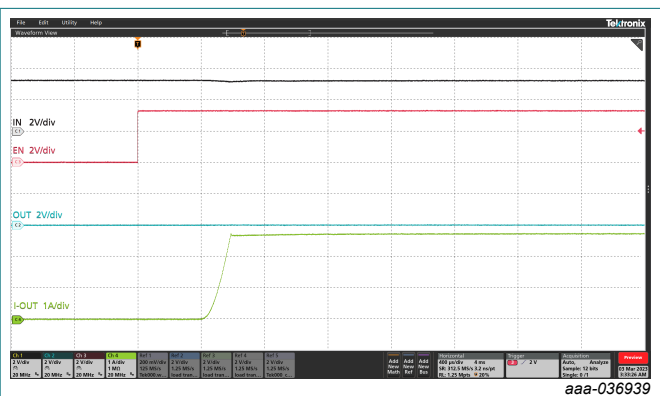


Fig. 8. Enable to short

5.5 V, 55 mΩ load switch with current limitation

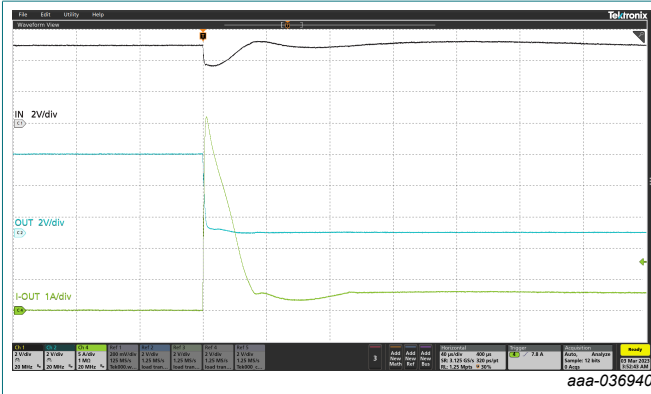


Fig. 9. Hard short

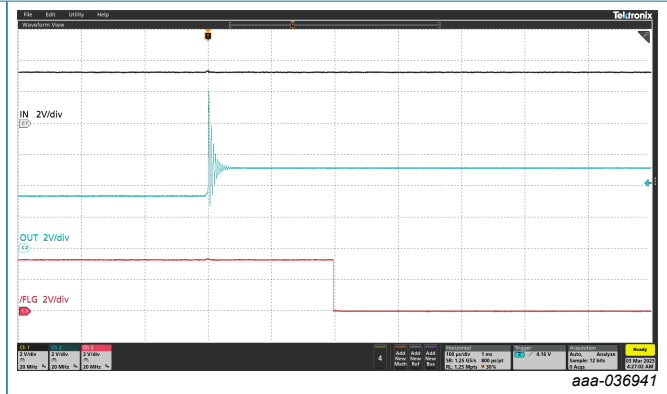


Fig. 10. Reverse voltage blocking

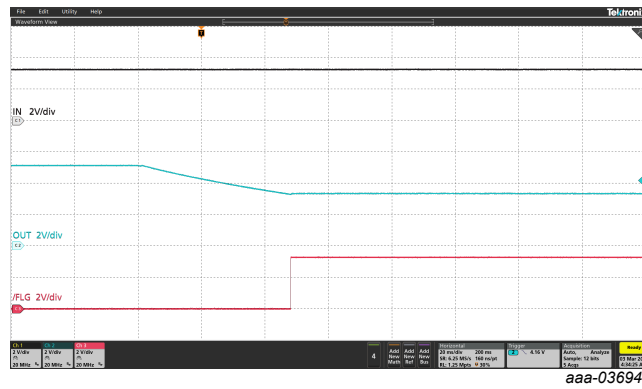
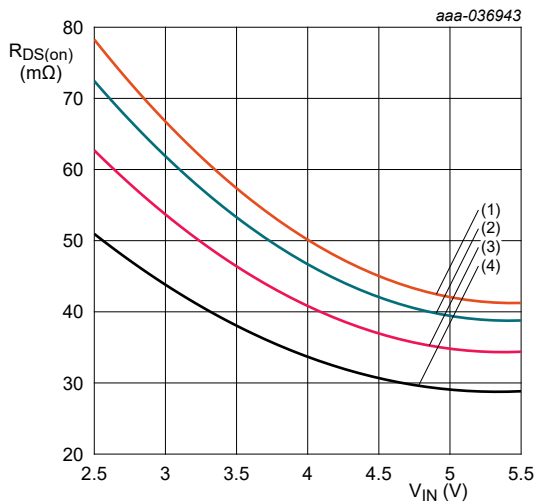
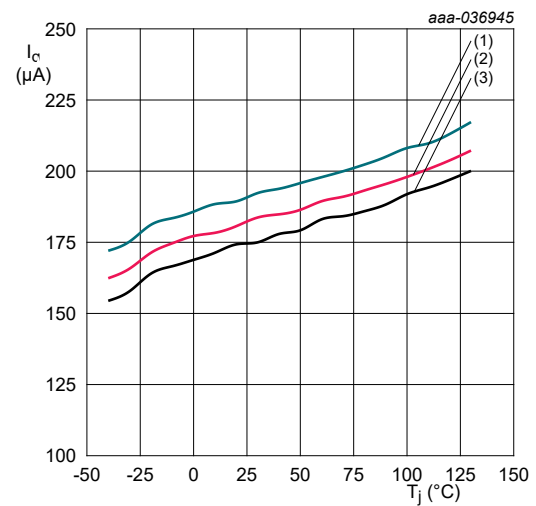


Fig. 11. Reverse voltage blocking



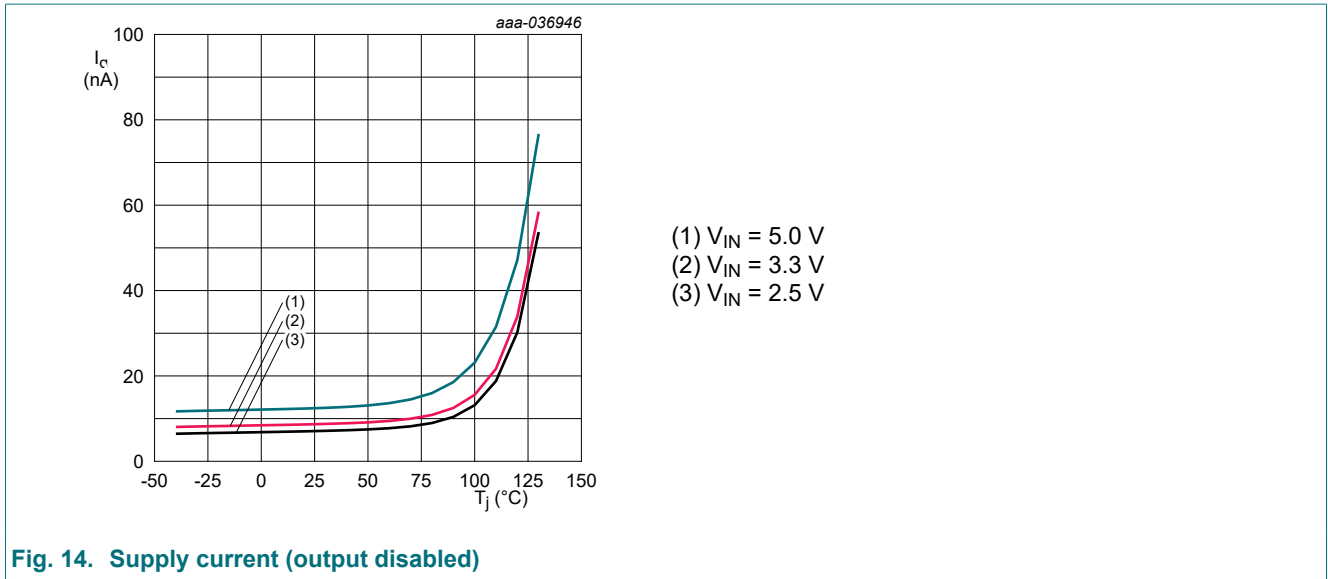
- (1)  $T_{amb} = 125\text{ °C}$
- (2)  $T_{amb} = 85\text{ °C}$
- (3)  $T_{amb} = 25\text{ °C}$
- (4)  $T_{amb} = -40\text{ °C}$

Fig. 12.  $R_{DS(on)}$  vs  $V_{IN}$



- (1)  $V_{IN} = 5.0\text{ V}$
- (2)  $V_{IN} = 3.3\text{ V}$
- (3)  $V_{IN} = 2.5\text{ V}$

Fig. 13. Supply current (output enabled)



## 12. Functional description

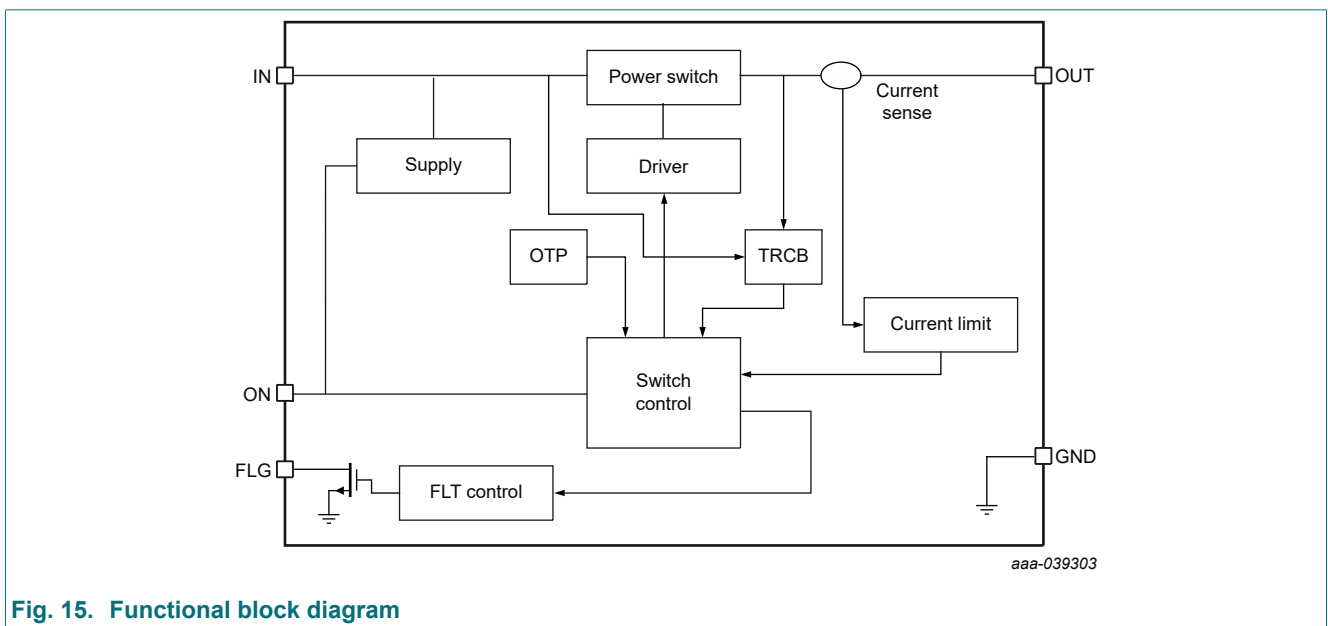
### 12.1. Overview

The NPS4001 is a 5.5 V, 55 mΩ P-channel load switch with overcurrent, overtemperature and active reverse voltage protections. The NPS4001 offers fixed current-limit thresholds for applications that require 2 A loading.

The NPS4001 has built in soft-start functionality and controls the rising and falling times of the output voltage to limit large current and voltage surges. Additional features include overtemperature protection and active reverse-voltage protection.

NPS4001 enters constant-current limit when the load exceeds the current limit threshold.

#### 12.1.1. Functional block diagram





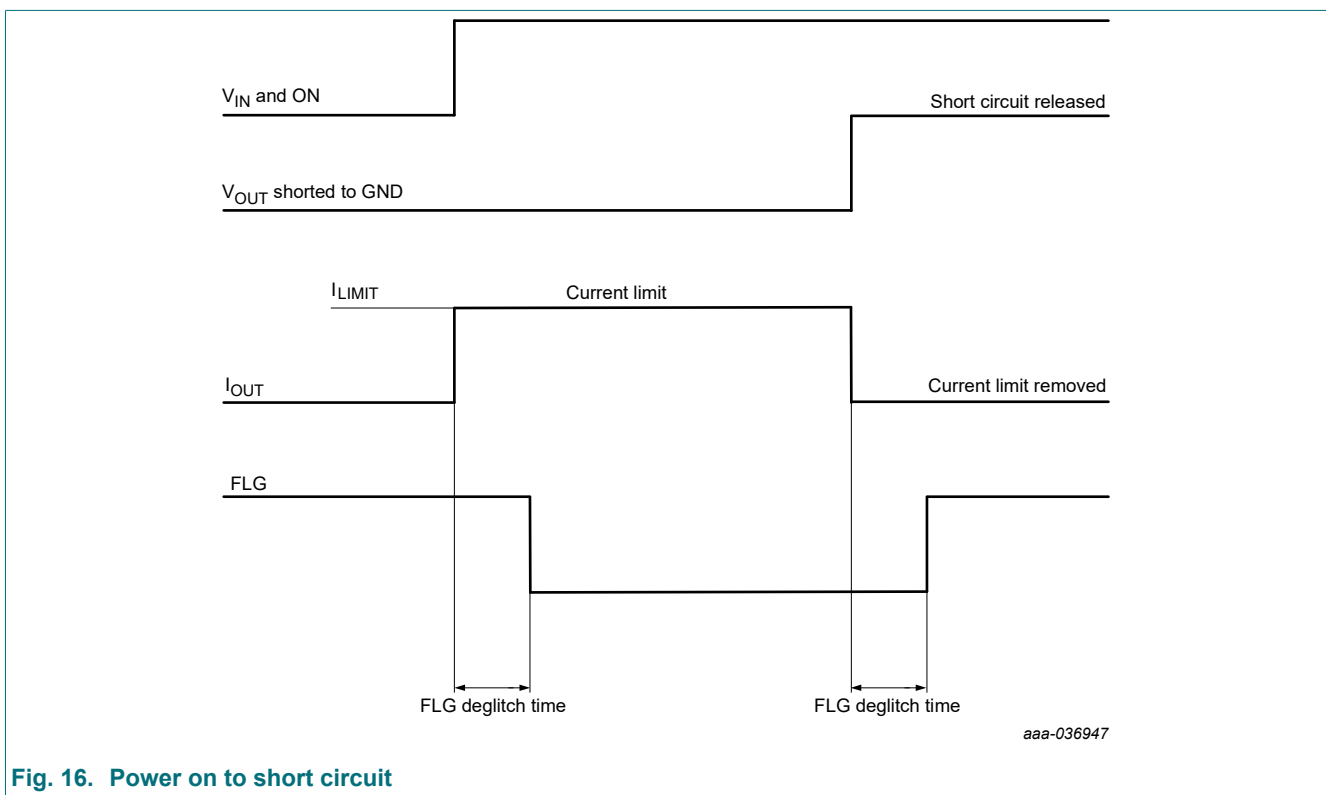
## 12.2. Feature description

### 12.2.1. Overcurrent protection

When the load current exceeds the current limit threshold set by the external resistor, the NPS4001 enters constant current mode by limiting the output current to the current limit threshold until the overcurrent condition is removed. FLG pin asserts if the overcurrent condition persists for 8.5 ms.

### 12.2.2. Output short circuit protection ( $I_{LIMIT}$ )

When the switch is turned on while the output pin is shorted to ground, the NPS4001 enters constant current mode immediately and limits the output current to  $I_{LIMIT}$  (see Fig. 16) until the short circuit condition is removed. When the output pin is shorted to ground while the switch is fully turned on, a large current will flow through the switch. The switch responds to short-circuit condition within the time  $t_{SC}$  (see Fig. 17). As in previous cases, NPS4001 limits the output current to  $I_{LIMIT}$  until the short circuit condition is removed.



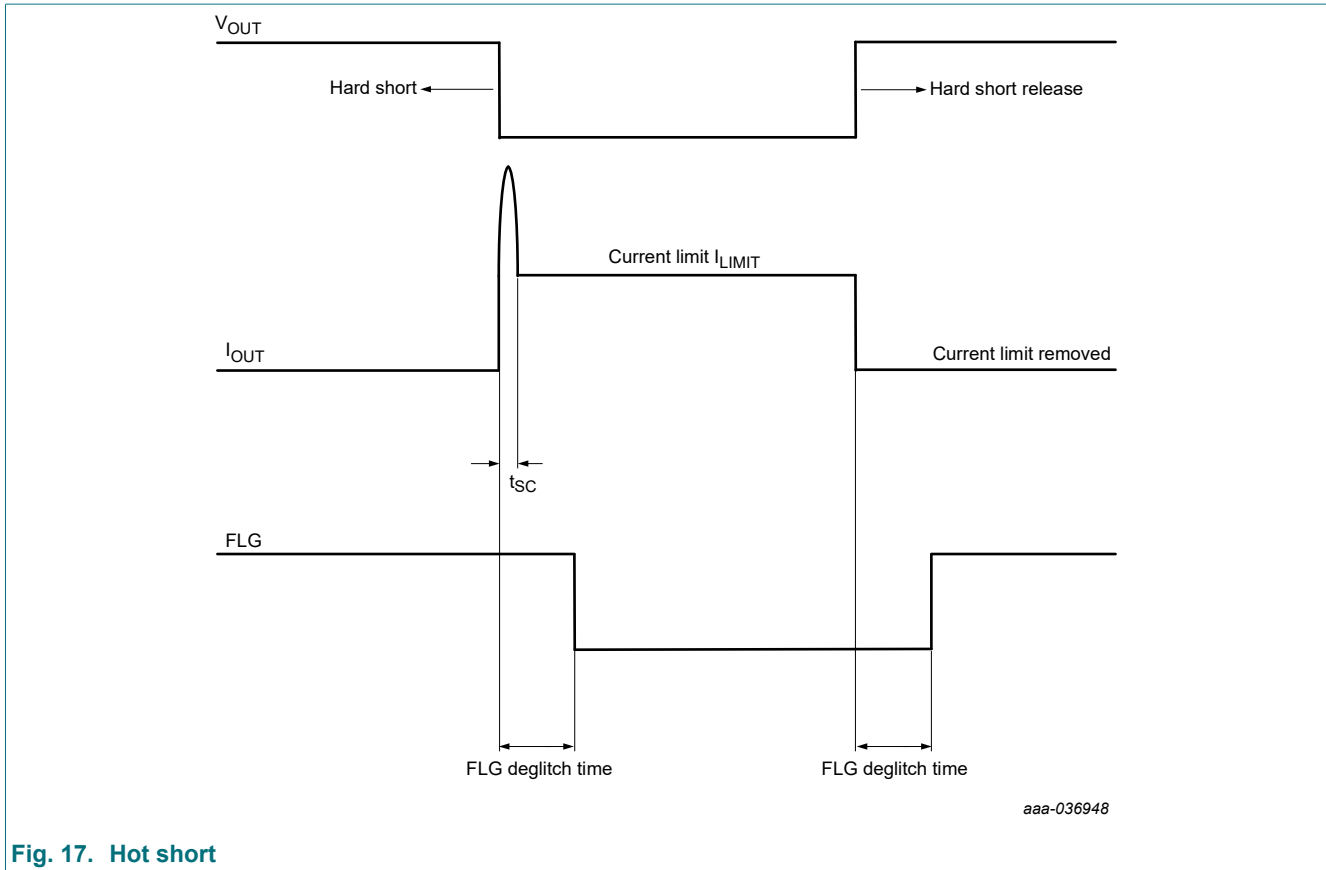


Fig. 17. Hot short

### 12.2.3. Output discharge

The NPS4001 integrates a 300  $\Omega$  pull-down resistor for quick output discharge when disabled.

### 12.2.4. Overtemperature protection

The NPS4001 thermal cycles if an over current condition is present long enough to activate thermal Limit in any of the above cases. The switch turns off when the junction temperature exceeds 155  $^{\circ}\text{C}$  (typical). The switch remains off until the junction temperature cools 10  $^{\circ}\text{C}$  (typical) and then restarts (see Fig. 18).  $FLG$  pin asserts immediately when the junction temperature exceeds 155  $^{\circ}\text{C}$ .

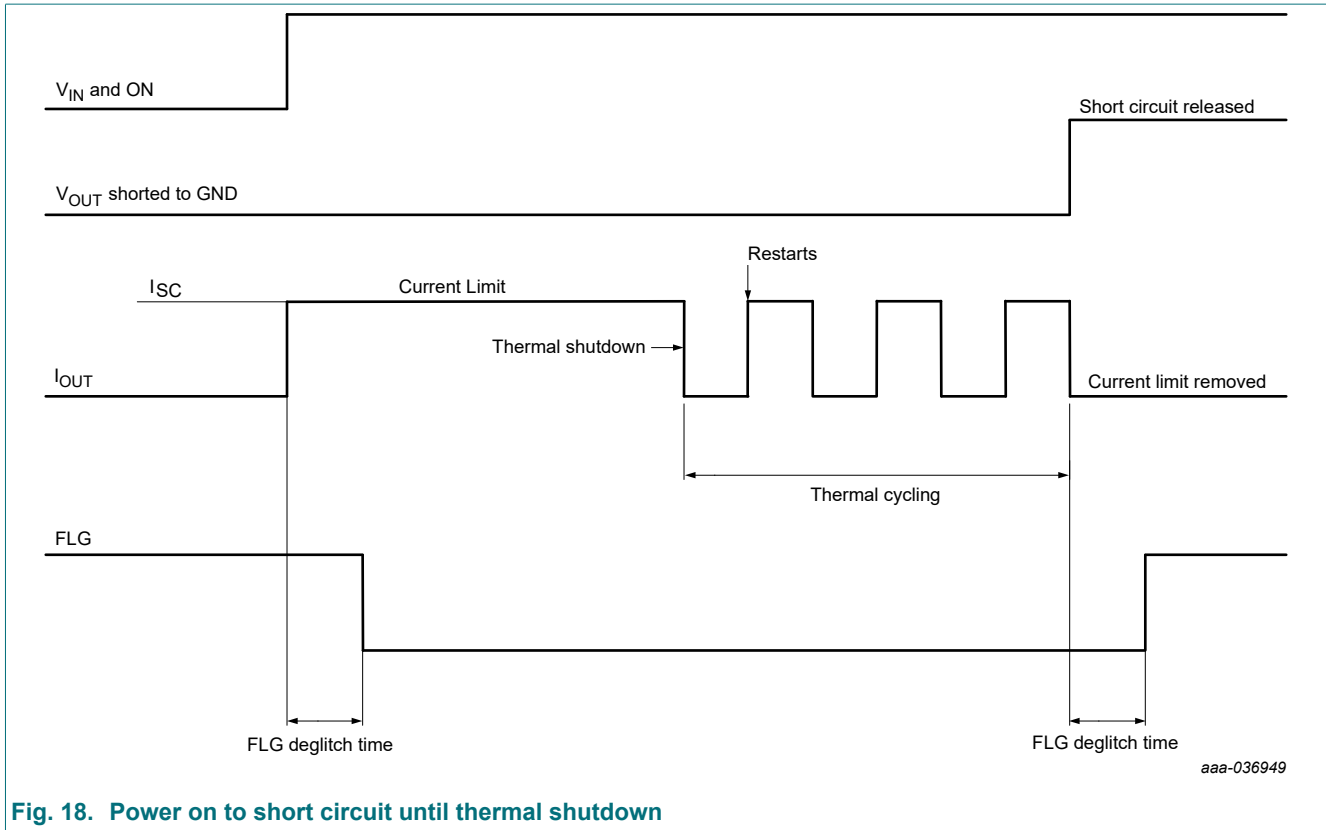


Fig. 18. Power on to short circuit until thermal shutdown

### 12.2.5. Reverse voltage protection

The NPS4001 integrates active reverse voltage protection. The switch turns off internal MOSFET whenever the output voltage exceeds the input voltage by 75 mV for 0.5 μs. The NPS4001 switch turns on once the reverse voltage condition is removed (see Fig. 19).  $FLG$  pin will assert low 0.2 ms after reverse voltage condition and de-assert after reverse voltage condition is removed.

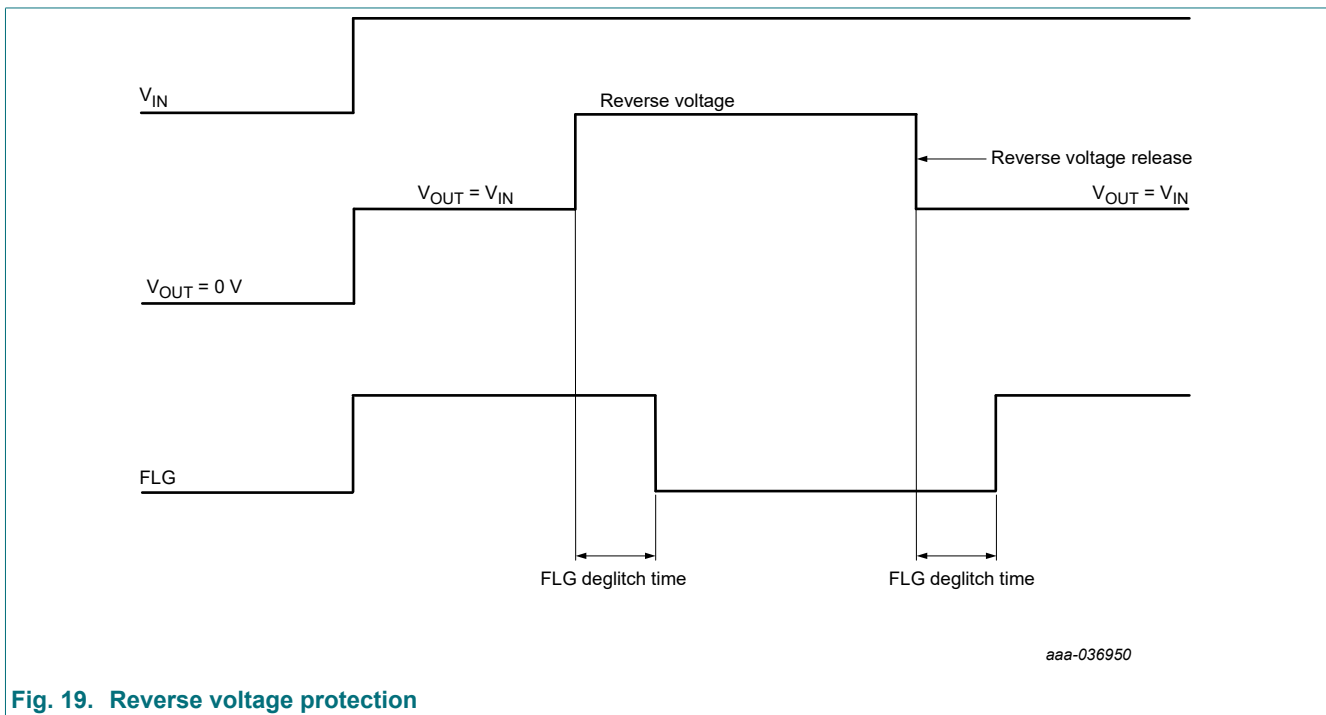


Fig. 19. Reverse voltage protection

### 12.2.6. FAULT flag response

Fault flag (pin FLG) output is an N-MOS open drain output. FLG pin is asserted low during overcurrent, overtemperature and reverse voltage conditions. An internal deglitch circuit is designed to eliminate false FLG reporting. Deglitch time for over current is 8.5 ms and that for reverse voltage is 0.2 ms. FLG pin voltage goes low 8.5 ms after over current and goes high 8.5 ms after over current condition is removed (see Fig. 16). FLG pin voltage goes low 0.2 ms after reverse voltage and goes high 0.2 ms after reverse voltage condition is removed (see Fig. 19). Overtemperature condition is not deglitched and asserts the FLG signal immediately when the junction temperature exceeds 155 °C. FLG pin can be shorted to ground or left floating when not used.

### 12.2.7. Undervoltage lockout (UVLO)

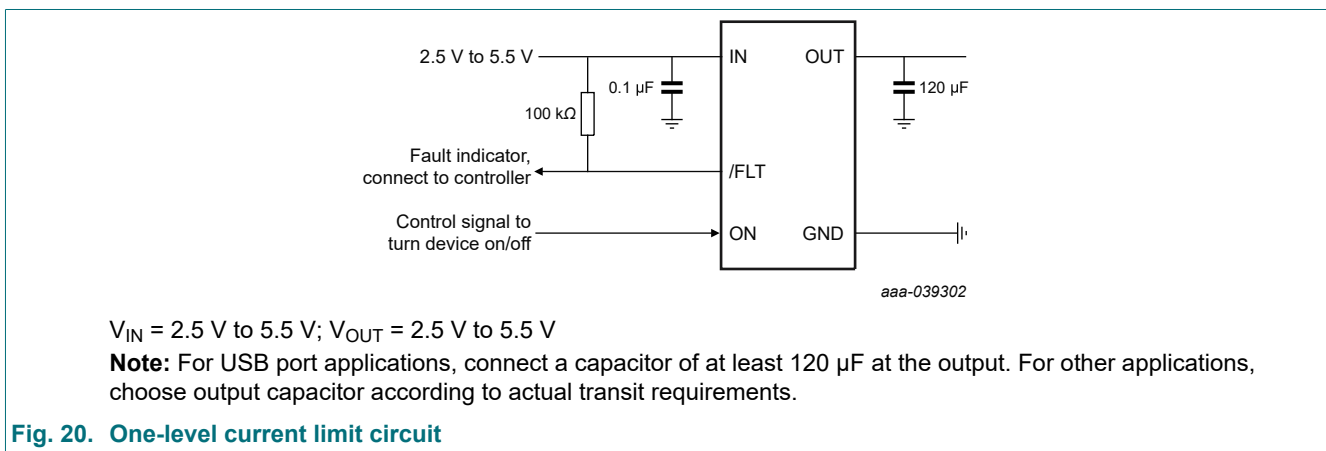
The undervoltage lockout (UVLO) circuit prevents the power switch from turning on until input voltage reaches the UVLO turn on threshold. Hysteresis is also built in to prevent unwanted on and off cycling due to input voltage drop from large current surges.

### 12.2.8. Enable (ON)

The logic enable (pin ON) circuit controls the power switch, a logic high enables the internal MOSFET. The enable input is compatible with both TTL and CMOS logic levels. The enable circuit also provides power to other circuits to reduce the supply current. The power supply current is reduced to less than 1 μA when a logic low is present on ON pin.

## 13. Application information

### 13.1.



## 14. Layout

### 14.1. Power supply recommendations

The NPS4001 is designed to operate with a  $V_{IN}$  range of 2.5 V to 5.5 V. The  $V_{IN}$  power supply must be well regulated and placed as close to the device terminal as possible. The power supply must be able to withstand all transient load current steps. In most situations, using an input capacitance ( $C_{IN}$ ) of 1 μF is sufficient to prevent the supply voltage from dipping when the switch is turned on. In cases where the power supply is slow to respond to a large transient current or large load current step, additional bulk capacitance may be required on the input.

## 14.2. Layout guidelines

For best performance, all traces must be as short as possible. To be most effective, the input and output capacitors must be placed close to the device to minimize the effects that parasitic trace inductances may have on normal operation. Using wide traces for  $V_{IN}$ ,  $V_{OUT}$ , and GND helps minimize the parasitic electrical effects.

## 14.3. Layout example

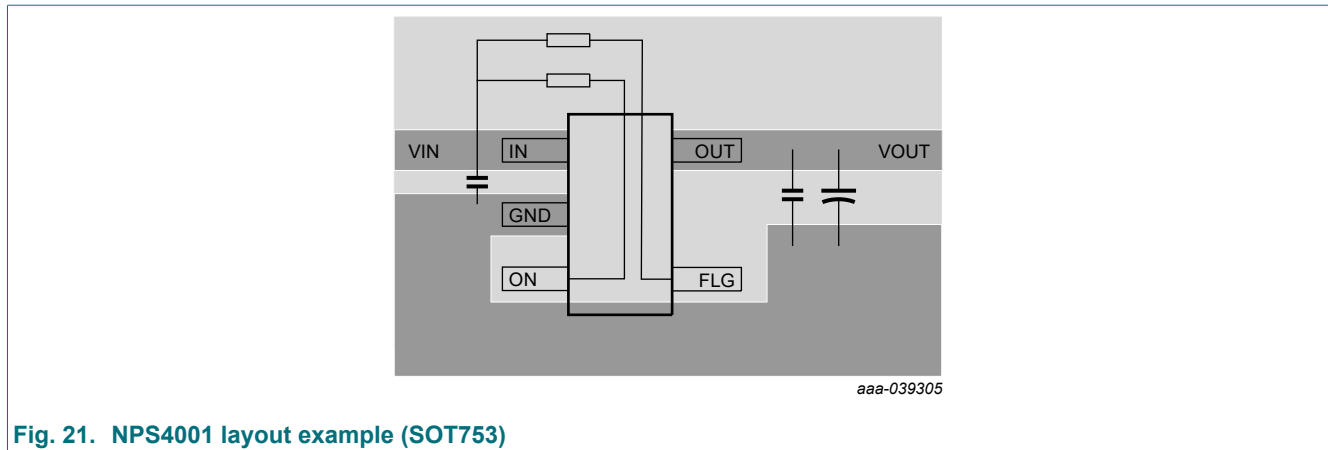


Fig. 21. NPS4001 layout example (SOT753)

## 15. Thermal considerations

The maximum IC junction temperature should be restricted to 125 °C under normal operating conditions. To calculate the maximum allowable dissipation,  $P_{D(max)}$  for a given output current and ambient temperature, the equation as shown below can be used:

$$P_{D(MAX)} = \frac{T_{J(MAX)} - T_{amb}}{\theta_{JA}}$$

Where:

$P_{D(MAX)}$  = maximum allowable power dissipation

$T_{J(MAX)}$  = maximum allowable junction temperature (125 °C for NPS4001)

$T_{amb}$  = ambient temperature of the device

$\theta_{JA}$  = junction to air thermal impedance. This parameter is highly dependent upon board layout.

## 16. Package outline

Plastic surface-mounted package; 5 leads

SOT753

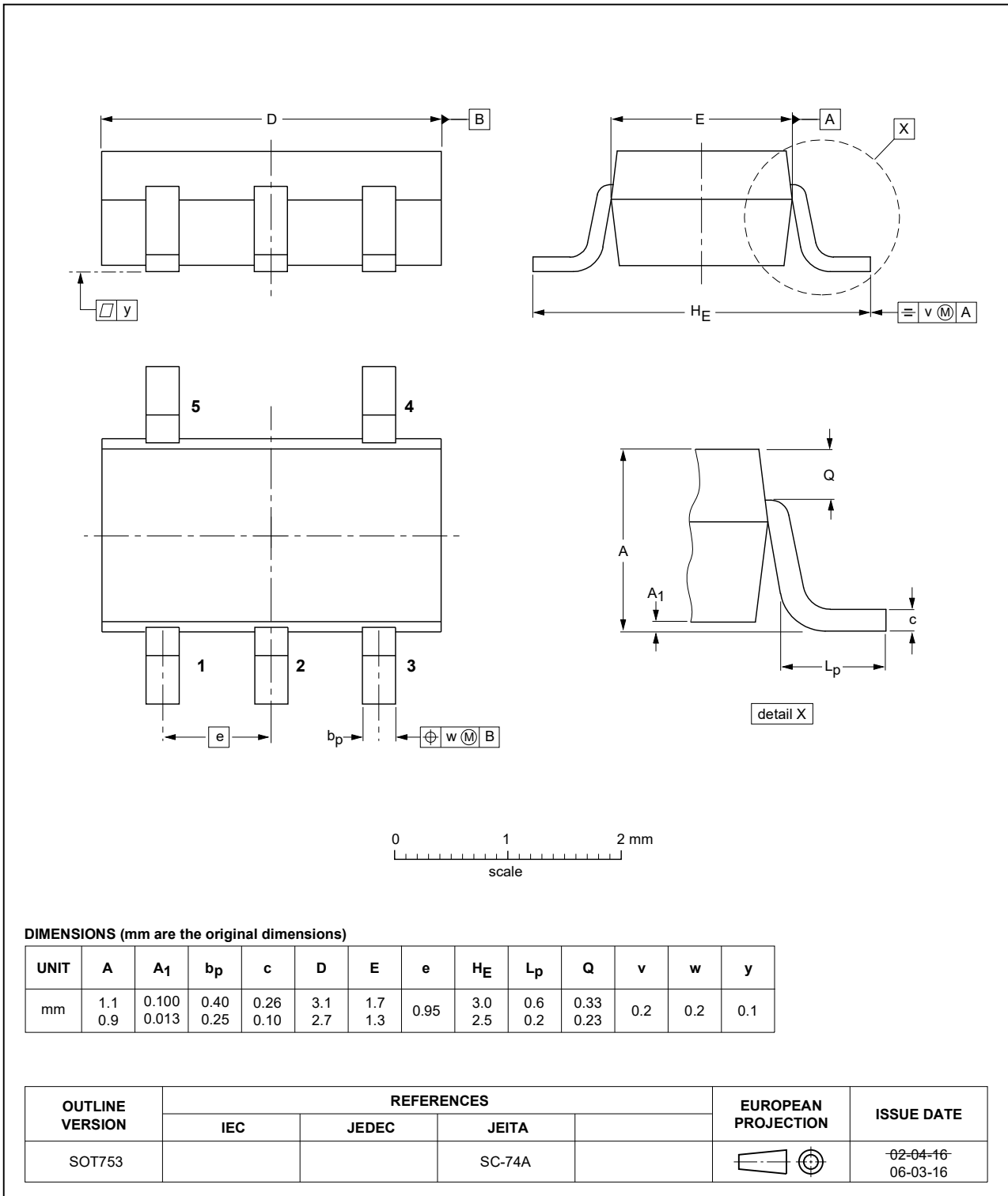


Fig. 22. Package outline SOT753 (SC-74A)

## 17. Abbreviations

Table 8. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
TTL	Transistor-Transistor Logic

## 18. Revision history

Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NPS4001 v.1	20240425	Product data sheet	-	-

## 19. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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 Date of release: 25 April 2024